



BOARD CHARACTERISTICS

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|---------------------------|-------------------------|--------------------|-----------|
| Copper Layer Count: | 4 | Board Thickness: | 1.6000 mm |
| Board overall dimensions: | 18.0000 mm x 37.0000 mm | | |
| Min track/spacing: | 0.2000 mm / 0.2000 mm | Min hole diameter: | 0.2000 mm |
| Copper Finish: | None | Impedance Control: | No |
| Castellated pads: | No | Plated Board Edge: | No |
| Edge card connectors: | No | | |